

FEATURES

- Low $r_{DS(on)}$
- High Y_{fs}/C_{iss} Ratio (High-Frequency Figure-of-Merit)

APPLICATIONS


Used in high-speed commutator and chopper applications. Also ideal for "Virtual Gnd" switching; needs no ext. translator circuit to switch ± 10 VAC. Can be driven direct from T²L or CMOS logic.

ABSOLUTE MAXIMUM RATINGS

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Drain-Gate Voltage	-25V
Drain-Source Voltage	-25V
Continuous Forward Gate Current	-10 mA
Storage Temperature Range	-65°C to +200°C
Operating Temperature Range	-55°C to +150°C
Lead Temperature (Soldering, 10 sec.)	+300°C
Power Dissipation	300 mW
Derate above 25°C	1.7 mW/°C

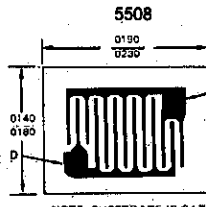
PIN CONFIGURATION



TO-72

D G C S

CHIP TOPOGRAPHY



5508

NOTE: SUBSTRATE IS GATE

ORDERING INFORMATION*

TO-72	WAFER	DICE
2N3993	2N3993/W	2N3993/D
2N3994	2N3994/W	2N3994/D

*When ordering wafer/dice refer to Appendix B-23.

ELECTRICAL CHARACTERISTICS @ 25°C free-air temperature (unless otherwise noted)

SYMBOL	PARAMETER	2N3993		2N3994		UNIT	TEST CONDITIONS (Note 3)
		MIN	MAX	MIN	MAX		
BV _{GSS}	Gate-Source Breakdown Voltage	25		25		V	$I_G = 1 \mu\text{A}$, $V_{DS} = 0$
I _{DGO}	Drain Reverse Current		-1.2		-1.2	nA	$V_{DG} = -15 \text{ V}$, $I_S = 0$
I _{DSS}	Zero-Gate-Voltage Drain Current	-10		-2		mA	$V_{DS} = -10 \text{ V}$, $V_{GS} = 0$, (See Note 1)
I _{D(off)}	Drain Cutoff Current				-1.2	nA	$V_{DS} = -10 \text{ V}$, $V_{GS} = 6 \text{ V}$
					-1	μA	$V_{DS} = -10 \text{ V}$, $V_{GS} = 6 \text{ V}$, $T_A = 150^\circ\text{C}$
			-1.2			nA	$V_{DS} = -10 \text{ V}$, $V_{GS} = 10 \text{ V}$
			-1			μA	$V_{DS} = -10 \text{ V}$, $V_{GS} = 10 \text{ V}$, $T_A = 150^\circ\text{C}$
V _{GS(off)}	Gate-Source Voltage	4	9.5	1	5.5	V	$V_{DS} = -10 \text{ V}$, $I_D = -1 \mu\text{A}$
r _{ds(on)}	Small-Signal Drain-Source On-State Resistance		150		300	Ω	$V_{GS} = 0$, $I_D = 0$, $f = 1 \text{ kHz}$
y _{fs}	Small-Signal Common-Source Forward Transfer Admittance	6	12	4	10	mmho	$V_{DS} = -10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ kHz}$, (See Note 1)
C _{iss}	Common-Source Short-Circuit Input Capacitance		16		16	pF	$V_{DS} = -10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$, (See Note 2)
C _{rss}	Common-Source Short-Circuit Reverse Transfer Capacitance				5	pF	$V_{DS} = 0$, $V_{GS} = 6 \text{ V}$, $f = 1 \text{ MHz}$
			4.5			pF	$V_{DS} = 0$, $V_{GS} = 10 \text{ V}$, $f = 1 \text{ MHz}$

NOTES: 1. These parameters must be measured using pulse techniques. $t_p = 100 \text{ ms}$, duty cycle $\leq 10\%$.

2. This parameter must be measured with bias voltage applied for less than 5 seconds to avoid overheating.

3. The case should be connected to the source for all measurements.